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FCD850N80Z / FCU850N80Z N-Channel SuperFET[®] II MOSFET

800 V, 6 A, 850 mΩ

Features

- Typ. R_{DS(on)} = 710 mΩ (Typ.)
- Ultra Low Gate Charge (Typ. Q_g = 22 nC)
- Low E_{oss} (Typ. 2.3 uJ @ 400V)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 106 pF)
- 100% Avalanche Tested
- RoHS Compliant
- ESD Improved Capability

Applications

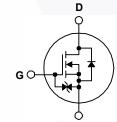
- AC DC Power Supply
- LED Lighting

Description

SuperFET[®] II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.







Absolute Maximum Ratings T_C=25°C unless otherwise noted.

Symbol		FCD850N80Z FCU850N80Z	Unit V			
V _{DSS}	Drain to Source Voltage			800		
V _{GSS}	Cata to Source Voltage	- DC		±20	V	
	Gate to Source Voltage	- AC	(f > 1 Hz)	±30	V	
I _D	Drain Current	- Continuous (T _C = 25 ^o C)		6	٨	
	Drain Current	- Continuous (T _C = 100 ^o C)		3.8	A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	18	Α	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			114	mJ	
I _{AR}	Avalanche Current (Note 1)			1.2	Α	
E _{AR}	Repetitive Avalanche Energy (Note 1)			0.284	mJ	
dv/dt	MOSFET dv/dt	100	V/ns			
	Peak Diode Recovery dv/dt (Note 3)				20	
P _D	Dower Discinction	(T _C = 25 ^o C)		75	W	
	Power Dissipation	- Derate Above 25°C		0.6	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FCD850N80Z FCU850N80Z	Unit			
$R_{ ext{ heta}JC}$	ermal Resistance, Junction to Case, Max. 1.65					
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	100	°C/W			

October 2014

Part Nun	nber	Top Mark	Package	Packing Method	Reel S	ize	Tape Wid	th C	Quantity	
FCD850N	180Z	FCD850N80Z	DPAK	Tape and Reel	330 m	m	16 mm	2	500 units	
FCU850N	180Z	FCU850N80Z	IPAK	Tube	NA		NA		75 units	
Electrica	l Char	acteristics T _C = 25°C	unless oth	erwise noted.						
Symbol		Parameter		Test Conditions	s	Min.	Тур.	Max.	Unit	
Off Charac	teristic	S								
BV _{DSS}		Source Breakdown Voltage	V _{CS} =	0 V, I _D = 1 mA, T _J =	= 25°C	800	-	-	V	
ΔBV _{DSS}	Breakdo	Breakdown Voltage Temperature		$I_D = 1$ mA, Referenced to 25°C			0.8	-	V/ºC	
DSS	Zero Gate Voltage Drain Current Gate to Body Leakage Current			$V_{DS} = 800 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_C = 125^{\circ}\text{C}$			-	25 250	μA	
000			-	$\pm 20 \text{ V}, \text{ V}_{\text{DS}} = 0 \text{ V}, \text{ I}$	C = 125 C	-	-	±10	μA	
GSS	Oale lu	body Leakage Guilent	VGS -	120 V, V _{DS} - 0 V		_		110	μΛ	
On Charac	teristic	S								
V _{GS(th)}	Gate Th	reshold Voltage	V _{GS} =	$V_{GS} = V_{DS}, I_{D} = 0.6 \text{ mA}$		2.5	-	4.5	V	
R _{DS(on)}	Static D	rain to Source On Resistand		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 3 \text{ A}$		-	710	850	mΩ	
ÐFS	Forward	d Transconductance		20 V, I _D = 3 A		-	3.5	-	S	
Dynamic C	haracte	eristics								
C _{iss}	Input Ca	apacitance					990	1315	pF	
Coss	Output (Capacitance		$V_{DS} = 100 V, V_{GS} = 0 V,$			28	37	pF	
Srss		e Transfer Capacitance	t = 1 N	f = 1 MHz			0.74	-	pF	
Coss		Capacitance	V _{DS} =	480 V, V _{GS} = 0 V, f	= 1 MHz	-	15	-	pF	
Coss(eff.)	Effective	e Output Capacitance		0 V to 480 V, V _{GS} =		-	106	-	pF	
$Q_{g(tot)}$		ate Charge at 10V		$V_{DS} = 640 \text{ V}, I_D = 6 \text{ A}, V_{GS} = 10 \text{ V}$		-	22	29	nC	
Q_{gs}		Source Gate Charge				-	5	-	nC	
 2 _{gd}		Drain "Miller" Charge			(Note 4)	-	8.6	-	nC	
ESR	Equivale	ent Series Resistance	f = 1 N	f = 1 MHz		-	2.4	-	Ω	
Switching	Charac	teristics								
d(on)	Turn-Or	Delay Time				-	16	42	ns	
r		Rise Time		400 V, I _D = 6 A,			10	30	ns	
t _{d(off)}	Turn-Of	Delay Time	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 4.7 \Omega$ (Note 4)			40	90	ns	
t _f	Turn-Off	Fall Time				-	4.5	19	ns	
Drain-Sou	ce Dioc	le Characteristics							I	
S	Maximum Continuous Drain to Source Diode Forward Current					-	-	6	Α	
SM		m Pulsed Drain to Source D				-	-	18	A	
V _{SD}		Source Diode Forward Volta				-	- /	1.2	V	
		Recovery Time		$V_{GS} = 0 V, I_{SD} = 6 A,$ $dI_F/dt = 100 A/\mu s$		-	318	-	ns	
<u>קריי</u> מיי		Recovery Charge				-	4.5	-	μC	
otes: . Repetitive rating . I _{AS} = 1.2 A, V _{DD}	: pulse width = 50 V, R _G = 200 Α/μs, V _[limited by maximum junction tempera = 25 Ω , Starting T _J = 25°C _{DD} ≤ BV _{DSS} , Starting T _J = 25°C erating temperature typical character							D	

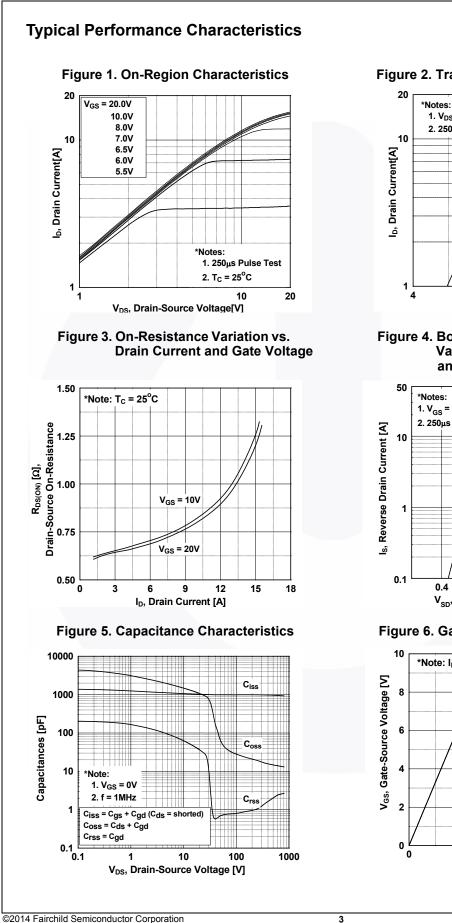


Figure 2. Transfer Characteristics

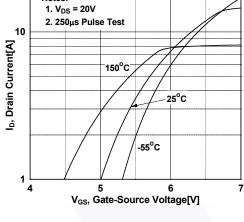


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

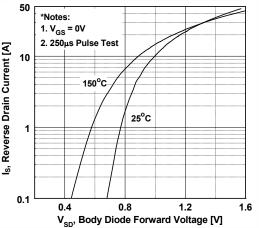
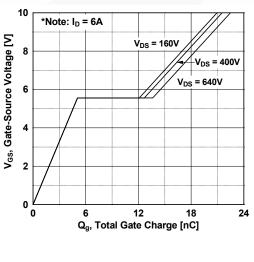
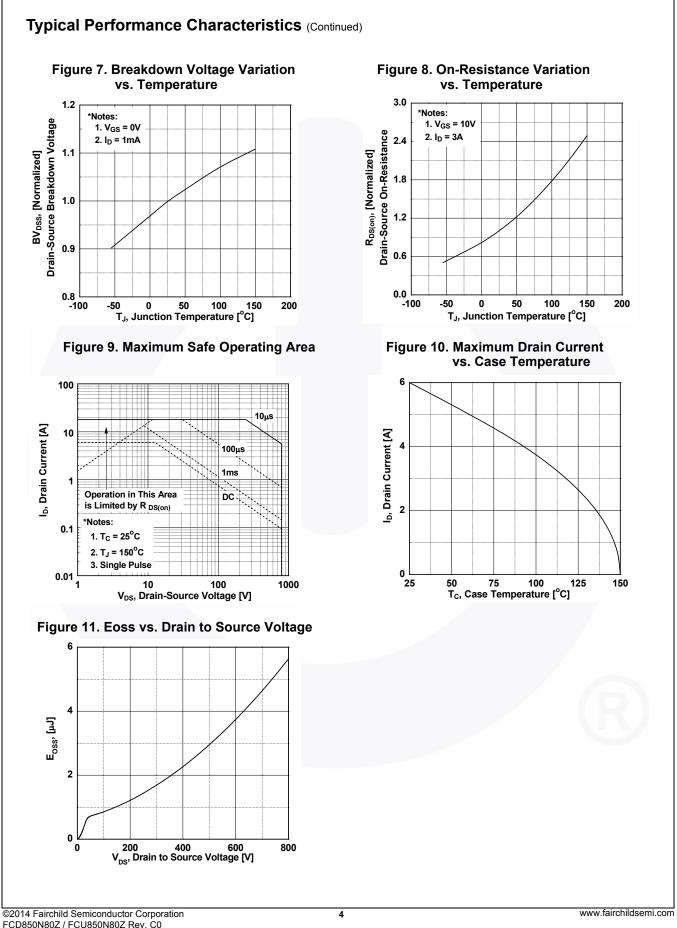
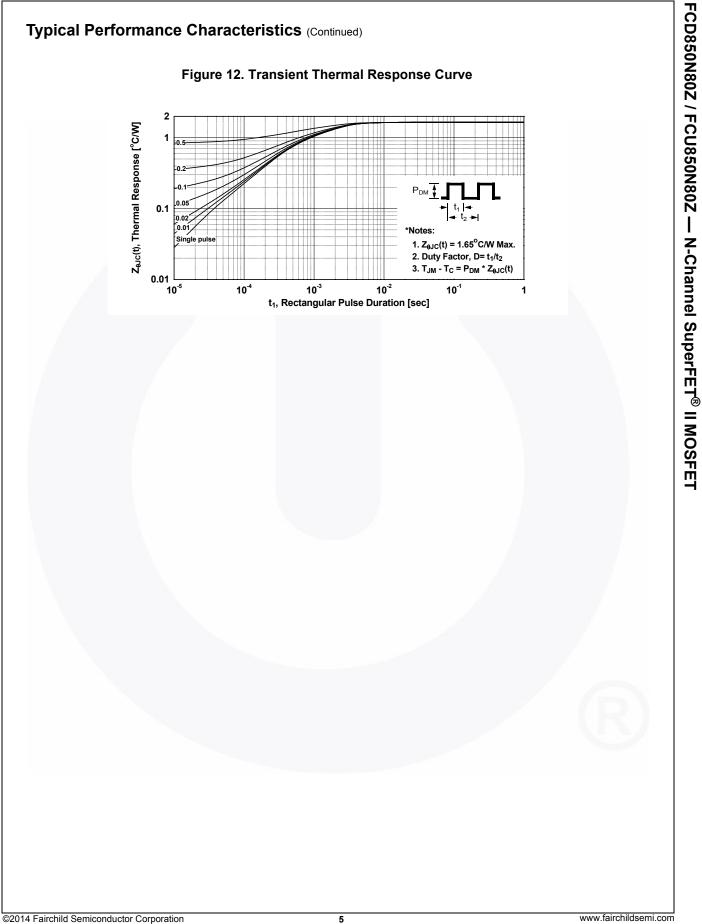
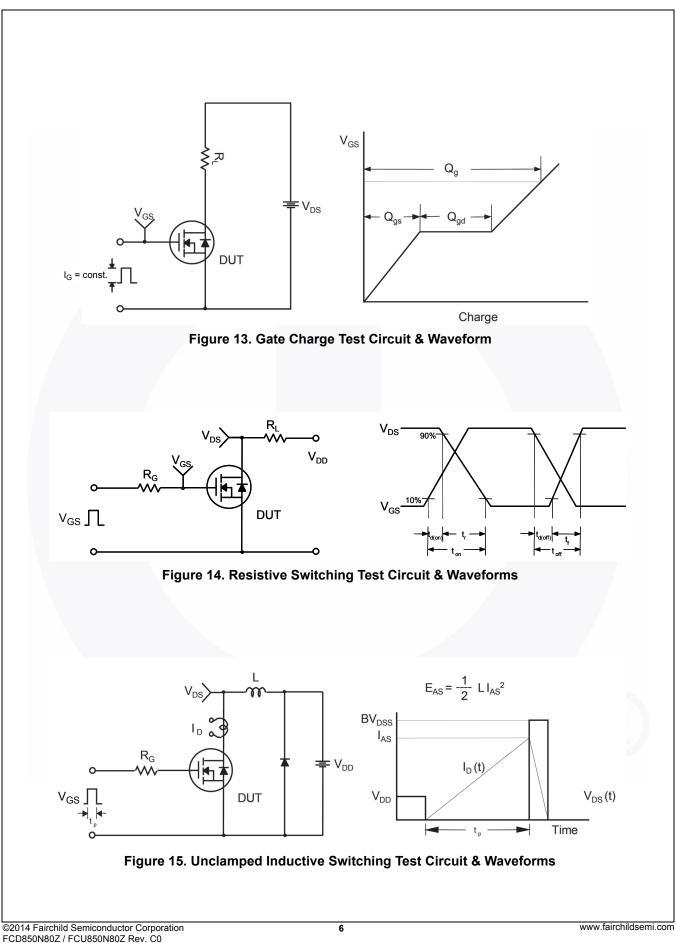


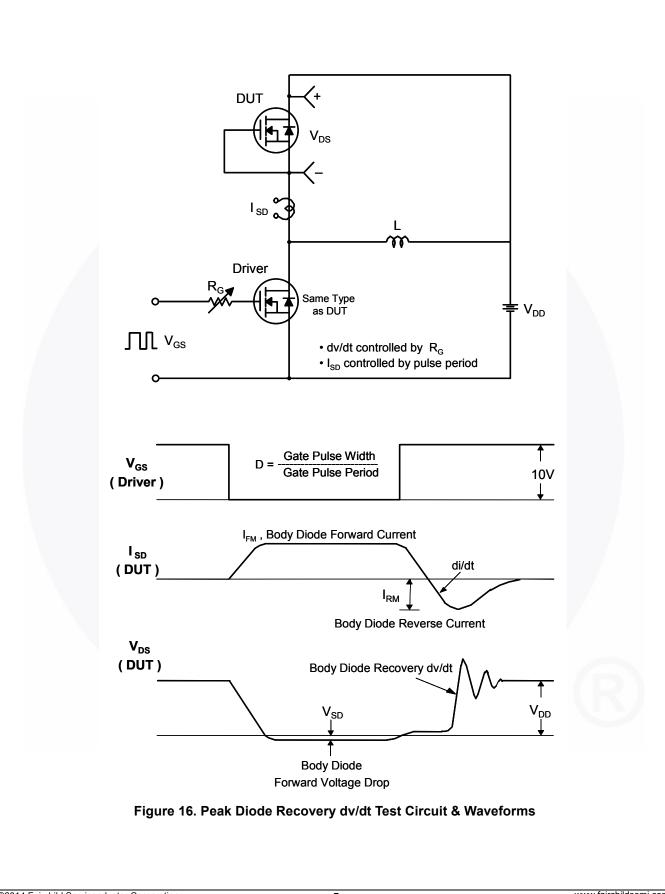
Figure 6. Gate Charge Characteristics

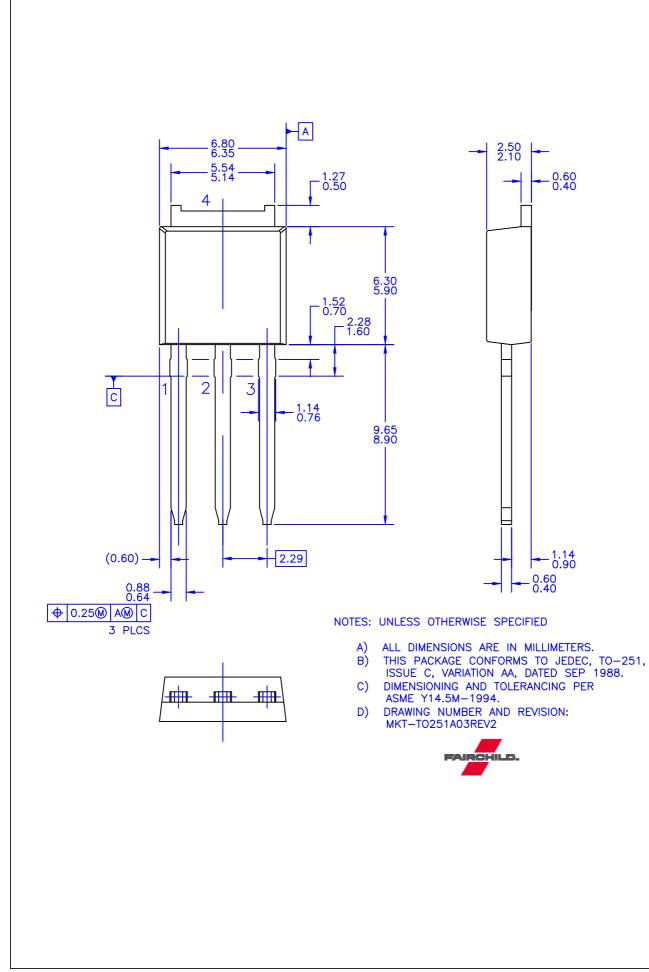




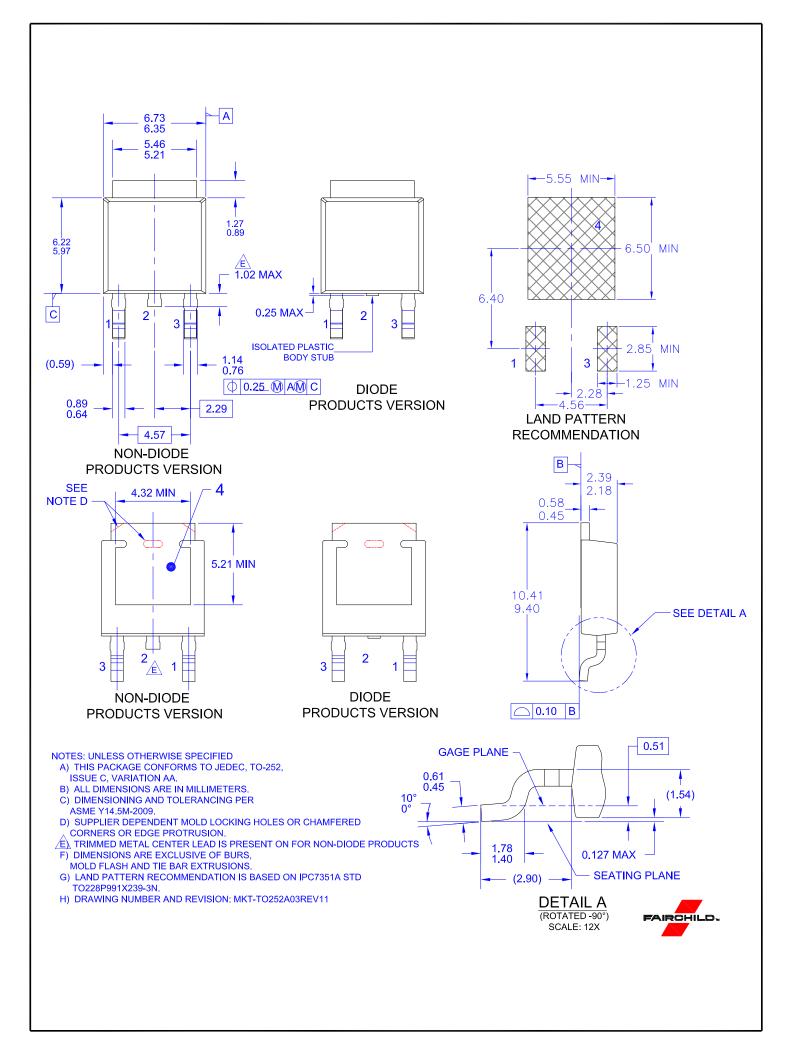








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